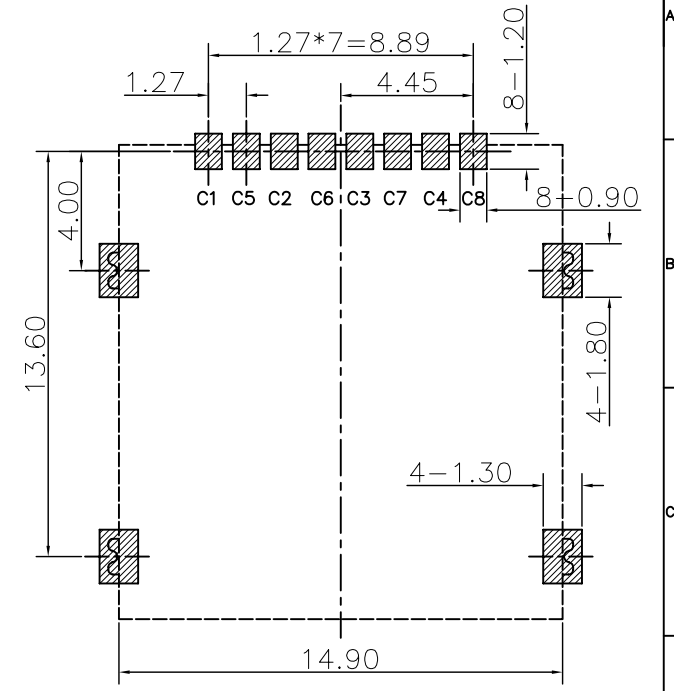
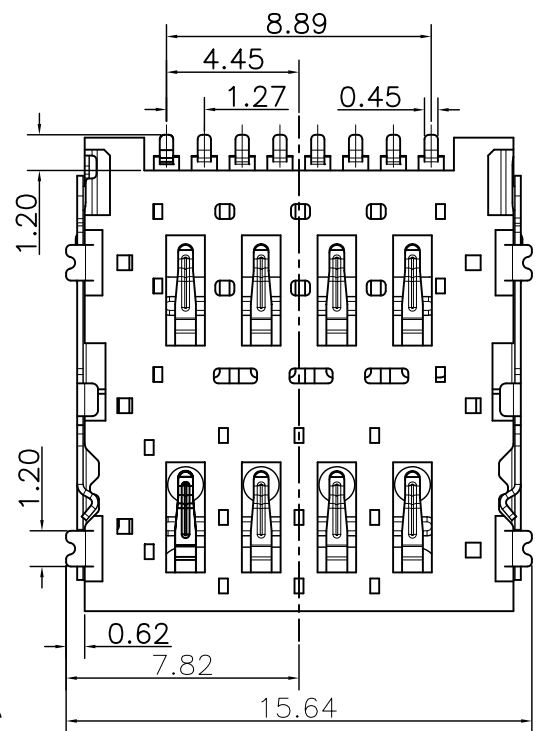
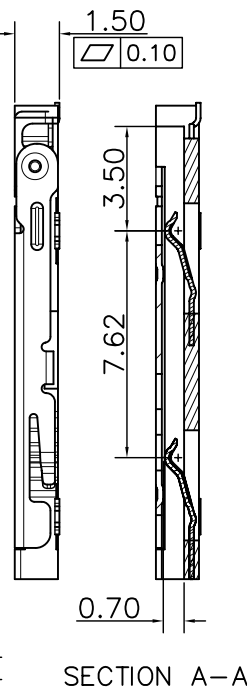
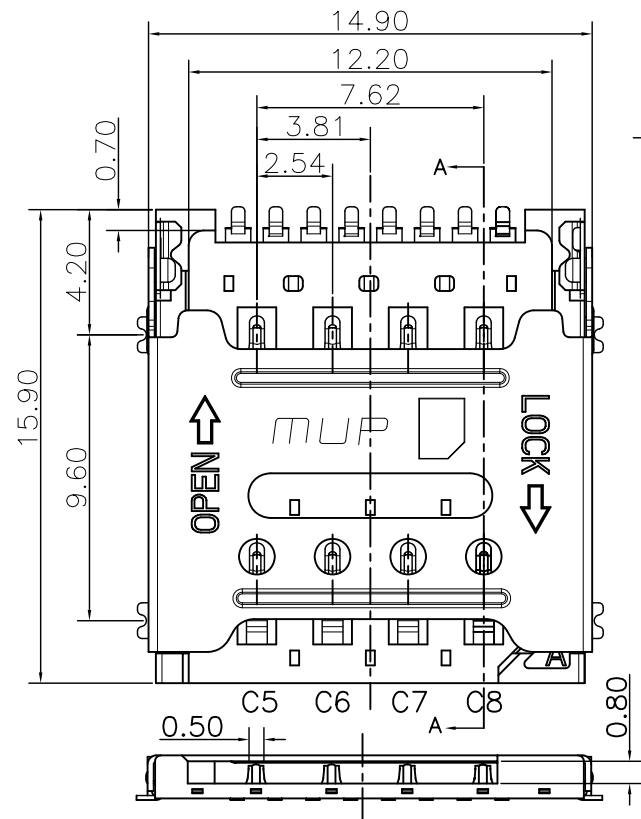
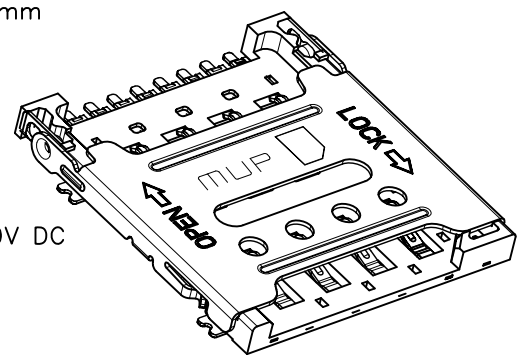


REV.	DESCRIPTION OF REVISIONS	APPR.	DRAW.	RELEASE	DATE
X1					
X2					



TECHNICAL CHARACTERISTICS

- General Characteristics**
 Dimensions: 15.90Lx14.90Wx1.50H mm
 Weight: Approx 0.53±0.2g
 Durability: 5,000 cycles min.
- Electrical Characteristics**
 Contact resistance: 50mΩ typical, 100mΩ max
 Insulation resistance: >1000MΩ/500V DC
- Solderability**
 Vaporphase: 215°C, 30sec. Max
 IR reflow: 250°C, 5sec. Max
 Manual soldering: 370°C, 3sec. Max
- Environmental Characteristics**
 Operating temperature: -40°C~+85°C
 Operating humidity: 10%~+95%RH



Micro SIM CARD	
Pin No.	NAME
C1	VCC
C2	RST
C3	CLK
C4	Reserved
C5	GND
C6	VPP
C7	I/O
C8	Reserved

ITEM	PART NAME	Q'TY	MATERIAL	FINISH
1	HOUSING	1	Hi-temp Thermoplastic	Black UL94V-0
2	DATA CONTACT	8	Copper Alloy	Contact area: Gold plated
3	SHELL	1	Stainless Steel	

Unless otherwise specified, other tolerance are:

X	±0.35	X'	±5'
X.X	±0.25	X.X'	±4'
X.XX	±0.15	X.XX'	±3'
X.XXX	±0.10	X.XXX'	±2'

MUP MUP INDUSTRIAL CO.,LTD.

NAME: **Micro-SIM Card Connector**
 MODEL NO: **MUP-C791**
 TYPE: **Hinge Type, 8 PIN, H1.50mm**

PROJ.	UNIT	SCALE	DRAWN	DWG NO.:
①	mm	1:1		DWG-MUP-C791-001
CUSTOMER DRAWING			CHECKED	SHEET
			APPROVAL	1/1
				REVISION
				X1

